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1	FEB 1 DECORDATION PATI	02-09-1999 100961891	PARTMENT OF COMMERCE and Trademark Office	
To t	ne Commissioner of Patents and Trademarks. Please reco	100901891	' thereof.	
1.	Name of conveying party(les):	2. Name and address of receivi	ng party(ies):	
	YUKIO SHISHIDO and SHUICHI KOBAYASHI $2.1.99$	Name: <u>Sony Corporation</u>		
	Additional name(s) of conveying party(ies) attached?	Internal Address:		
	Yes X No	Street Address: 7-35, Kitashinagawa 6-Chome City, State and Zip: Shinagawa-ku, Tokyo 141-0001, JAPAN		
3.	Nature of Conveyance:	Additional Name (-) (Conditional Conditional Condition	-	
X	Assignment	Additional Name(s) & address(e	X No	
	Execution Date: January 11, 1999 and January 21, 1999			
4 -	Application number(s) or patent number(s): If this document is being filed together with a new applica A. Patent Application No. 09/184,822 B. Filed: November 2, 1998 Additional numbers attached?	B. Patent No.(s) Yes X No	pplication is:	
5.	Name and address of party to whom correspondence concerning document should be mailed:			
	Name: Charles P. Sammut	7. Total fee (37 CFR 3.41):	\$ 40.00	
	Internal Address: Limbach & Limbach L.L.P. Street Address: 2001 Ferry Building City, State, ZIP: San Francisco, California 94111 Telephone: (415) 433-4150 Facsimile: (415) 433-8716	X Enclosed Charge any deficienci Deposit Account No. 1 Authorized to be charged	es in the enclosed fee to 2-1420 to deposit account	
	Attorney Docket No. SONY-Q8319	8. Deposit account number: 12	?-1420	
	DO NOT USE	THIS SPACE		
9.	Statement and signature.			
	To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.			
	Charles P. Sammut, Reg. No. 28,901 Name of Person Signing	Signature	January 27, 1999 Date	
2/08	/1999 DMBUYEN 00000169 09184822 Total number of	pages including cover sheet, atta	achments and document: 3	
1 FC	581 40.00 QP			
		h this portion		
	Mail documents to be recorded with required cover sheet information to: Commissioner of Patents and Trademarks,	Box Assignments Washington D.C. 20	221	
	Public burden reporting for this sample cover sheet is estimated to average at document and gathering the data needed, and completing and reviewing the s Patent and Trademark Office, Office of Information Systems, PK2-1000C, Was Reduction Project. (0651-0011). Washington, D.C. 20503	pout 30 minutes per document to be recorde ample cover sheet. Send comments regardi	d, including time for reviewing the	

REEL: 9741 FRAME: 0102

Docket Number: SONY-08319

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in REPRODUCING APPARATUS AND CACHING METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/184,822, Filing Date November 2, 1998

This assignment executed on the dates indicated below.

YUKIO SHISHIDO	
Name of first or sole inventor	Execution date of U.S. Patent Application
KANAGAWA JAPAN	
Residence of first or sole inventor	
Ejukio Shishido	January 11, 1999
Signature of first or sole inventor	Date of this assignment

PATENT REEL: 9741 FRAME: 0103

Execution date of U.S. Patent Application Jan. 4, 199 Date of this assignment
Date of this assignment
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Execution date of U.S. Patent Application
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Execution date of U.S. Patent Application
Date of this assignment
Execution date of U.S. Patent Application
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PATENT REEL: 9741 FRAME: 0104

Date of this assignment

ature of fifth inventor